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March 2015



FDD3690

100V N-Channel PowerTrench[®] MOSFET

General Description

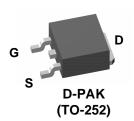
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

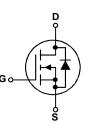
These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable $R_{\text{DS}(\text{ON})}$ specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

Features

- 22 A, 100 V. $R_{DS(ON)} = 64 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 71 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- Low gate charge (28nC typical)
- Fast Switching
- High performance trench technology for extremely low R_{DS(ON)}
- High power and current handling capability





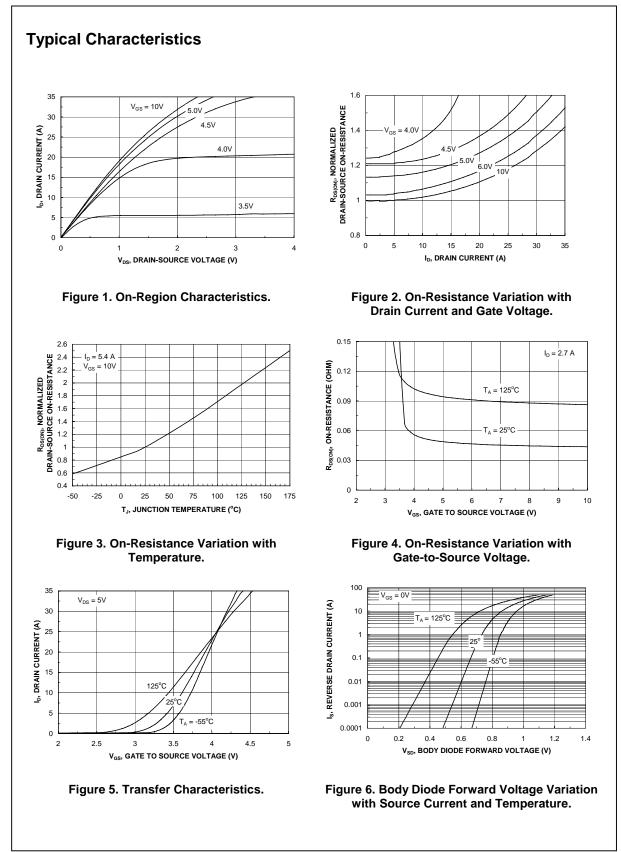
Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Source Voltage			100		
V _{GSS}	Gate-Source Voltage			±20	V	
l _D	Continuous Drain Current	@T _c =25°C	(Note 3)	22	A	
		Pulsed	(Note 1a)	75		
P _D	Power Dissipation	@T _c =25°C	(Note 3)	60	W	
		@T _A =25°C	(Note 1a)	3.8		
		@T _A =25°C	(Note 1b)	1.6		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175		
Thorma						
	Al Characteristics Thermal Resistance, Junc	tion-to-Case	(Note 1)	2.5	°C/W	
R _{θJC}			(Note 1) (Note 1a)	2.5 40		
R _{θJC}	Thermal Resistance, Junc	tion-to-Ambient	()		°C/W	
R _{ejc} R _{eja} R _{eja}	Thermal Resistance, Junc Thermal Resistance, Junc	tion-to-Ambient tion-to-Ambient	(Note 1a) (Note 1b)	40	°C/W	
R _{ejc} R _{eja} R _{eja}	Thermal Resistance, Junc Thermal Resistance, Junc Thermal Resistance, Junc e Marking and Orc	tion-to-Ambient tion-to-Ambient dering Info	(Note 1a) (Note 1b)	40	°C/W ○C/W ○C/W Quantity	

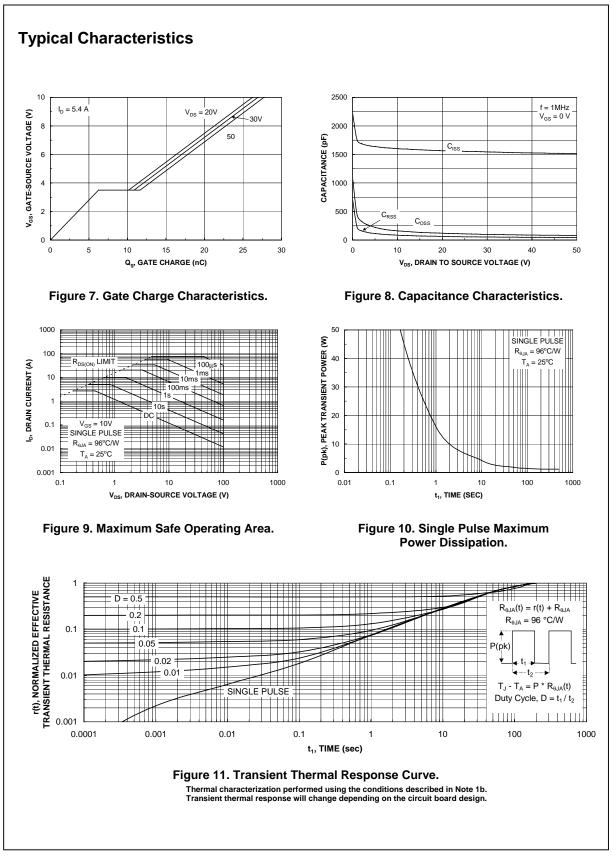
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Symbol	Parameter	Test	Conditions	Min	Тур	Max	Units
- Drain-So	ource Avalanche Ratings (Not	e 2)					
W _{DSS}	Single Pulse Drain-Source Avalanche Energy	$V_{DD} = 50 \text{ V},$	I _D = 5.4 A			175	mJ
AR	Maximum Drain-Source Avalanche Current					5.4	A
Off Char	acteristics						
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$,	I _D = 250 μA	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_{D} = 250 \ \mu A, F$	Referenced to 25°C		78		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80 V$,				10	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 V$,	$V_{DS} = 0 V$			100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	$V_{GS} = -20 V$	$V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D =$	= 250 μA	2	2.4	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C			-6.2		mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 V,$ $V_{GS} = 6 V,$ $V_{GS} = 10 V, I_D$	$I_D = 5.4 \text{ A}$ $I_D = 5.2 \text{ A}$ $= 5.4 \text{ A}, \text{T}_J = 125^{\circ}\text{C}$		44 47 88	64 71 135	mΩ
I _{D(on)}	On-State Drain Current	V_{GS} = 10 V,		20			А
g fs	Forward Transconductance		I _D = 5.4 A		20		S
Dvnamic	Characteristics						
C _{iss}	Input Capacitance	$V_{DS} = 50 V$,	$V_{GS} = 0 V,$		1514		pF
C _{oss}	Output Capacitance	f = 1.0 MHz			82		pF
C _{rss}	Reverse Transfer Capacitance				44		pF
Switchin	g Characteristics (Note 2)						
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 50 V$,	$I_{\rm D} = 1 {\rm A},$		11	20	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 V$,	$R_{GEN} = 6 \Omega$		6.5	15	ns
t _{d(off)}	Turn–Off Delay Time				29	60	ns
t _f	Turn–Off Fall Time				10	20	ns
Q _g	Total Gate Charge	$V_{DS} = 50 V$,	I _D = 5.4 A,		28	39	nC
Q _{gs}	Gate–Source Charge	V_{GS} = 10 V			6.2		nC
Q _{gd}	Gate–Drain Charge				5.4		nC
Drain-Se	ource Diode Characteristics	and Maxim	um Ratings				
ls	Maximum Continuous Drain-Sourc		-			3.2	А
V _{SD}	Drain-Source Diode Forward Volta	ge $V_{GS} = 0 V$,	I _S = 3.2 A (Note 2)		0.73	1.2	V
	of the junction-to-case and case-to-ambient then $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is deter a) $R_{\theta JA} = 40^{\circ}C/1$ $1in^2$ pad of 2	rmined by the user's N when mounted on	board design.	b) R _{eJ} a		when mou	
		Scale 1 : 1 on I	etter size paper				
Pulse Test: Pu	lse Width < 300μs, Duty Cycle < 2.0%						
	ent is calculated as: $\sqrt{\frac{P_{D}}{R_{DS(ON)}}}$						

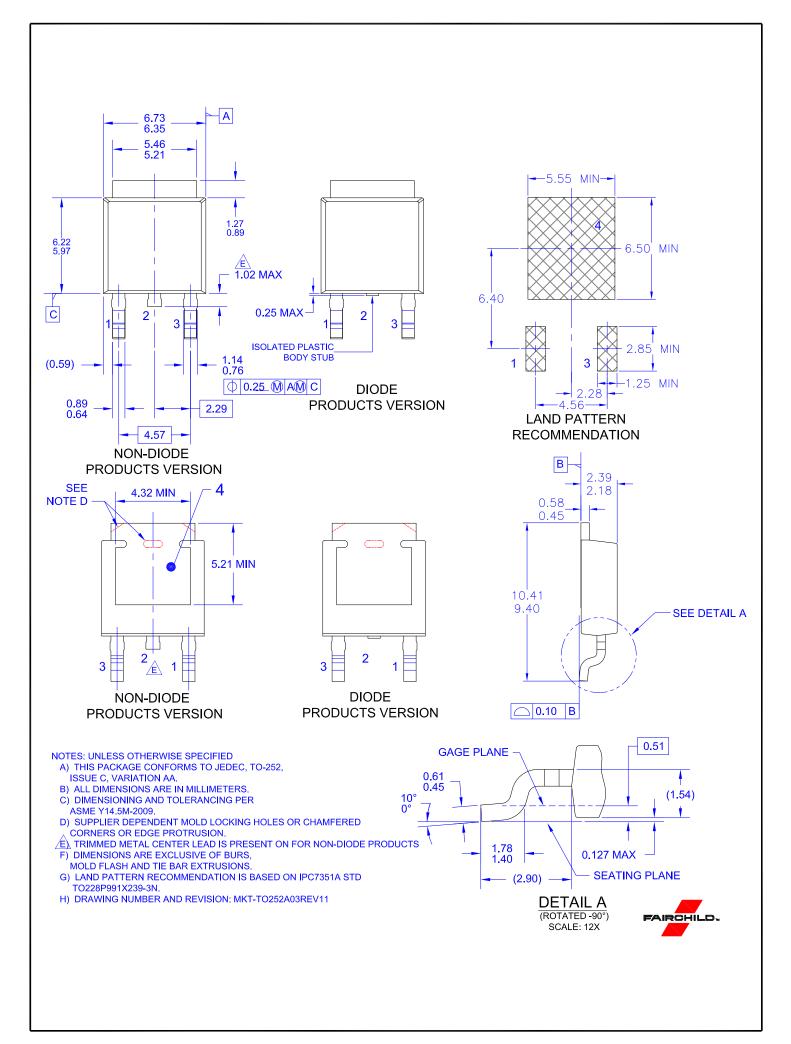
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